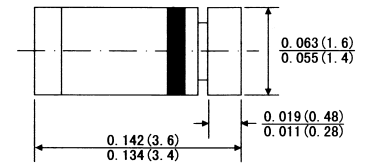


FEATURES

- . In MiniMELF case especially for automated insertion
- The zener voltage are graded according to the international E24 standard. Smaller voltage tolerances and higher zener voltage on request

Mini-MELF

Dimensions in inches and (millimeters)

MECHANICAL DATA

- . **Case:** Mini-MELF(SOD-80) glass case
- . **weight:** Approx. 0.05 gram

ABSOLUTE MAXIMUM RATINGS(LIMITING VALUES)(TA=25°C)

	Symbols	Value	Units
Zener current see table "Characteristics"			
Power dissipation at TA=25°C	P _{tot}	500 ¹⁾	mW
Junction temperature	T _J	175	°C
Storage temperature range	T _{STG}	-55 to +175	°C
1) Valid provided that a distance of 8mm from case are kept at ambient temperature			

ELECTRICAL CHARACTERISTICS(TA=25°C)

	Symbols	Min	Typ	Max	Units
Thermal resistance junction to ambient	R _{θJA}			300 ¹⁾	K/W
1) Valid provided that a distance at 8mm from case are kept at ambient temperature					

ZMM1 THRU ZMM200 SILICON PLANAR ZENER DIODES

Type	Zener Voltage range 1)			Dynamic resistance 1)			Maximum reverse Leakage Current			of zener voltage										
	V _{znom} 3)	I _{zT}		r _{zjt} and r _{zjk} at I _{zk}			I _R and I _R at V _R 2)			TK _{vz}										
	v	mA	V	Ω	Ω	mA	μ A	μ A	V	%/K										
ZMM1 3)	0.75	5	0.7.0.8	<8	<50	1	--	--	--	-0.26..0.23										
ZMM2.0	2.0		1.9.2.1	<85	<600		<100	<200	1	-0.09..0.06										
ZMM2.4	2.4		2.28.2.56				<50	<100		-0.09..0.06										
ZMM2.7	2.7		2.5.2.9				<10	<50		-0.09..0.06										
ZMM3.0	3.0		2.8.3.2				<4	<40		-0.08..0.05										
ZMM3.3	3.3		3.1.3.5				<2			-0.08..0.05										
ZMM3.6	3.6		3.4.3.8				<2			-0.08..0.05										
ZMM3.9	3.9		3.7.4.1				<2			-0.08..0.05										
ZMM4.3	4.3		4.0.4.6	<75			<1	<20		-0.06..0.03										
ZMM4.7	4.7		4.4.5.0	<60			<0.5	<10		-0.05.+0.05										
ZMM5.1	5.1		4.8.5.4	<35	<550		<0.1	<2	2	-0.02.+0.02										
ZMM5.6	5.6		5.2.6.0	<25	<450					-0.05.+0.05										
ZMM6.2	6.2		5.8.6.6	<10	<200					0.03.0.06										
ZMM6.8	6.8		6.4..7.2	<8	<150					0.03.0.07										
ZMM7.5	7.5		7.0..7.9	<7	<50					0.03.0.08										
ZMM8.2	8.2		7.7.8.7	<7						0.03.0.09										
ZMM9.1	9.1		8.5.9.6	<10						0.03.0.1										
ZMM10	10		9.4..10.6	<15	<70					0.03.0.11										
ZMM11	11		10.4..11.6	<20	<70					0.03.0.11										
ZMM12	12		11.4..12.7	<20	<90					0.03.0.11										
ZMM13	13		12.4..14.1	<26	<110					0.03.0.11										
ZMM15	15		13.8..15.6	<30	<110					0.03.0.11										
ZMM16	16		15.3..17.1	<40	<170					0.03.0.11										
ZMM18	18		16.8..19.1	<50	<170					0.03.0.11										
ZMM20	20		18.8..21.2	<55	<220					0.03.0.11										
ZMM22	22		20.8..23.3	<55						0.04.0.12										
ZMM24	24		22.8..25.6	<80																
ZMM27	27		25.1..28.9																	
ZMM30	30		28..32																	
ZMM33	33		31..35																	
ZMM36	36		34..38																	
ZMM39	39	2.5	37..41	<90	<500		<5	<10	30											
ZMM43	43		40..46																	
ZMM47	47		44..50								<110	<600	33							
ZMM51	51		48...54								<125	<700		36						
ZMM56	56		52..60	<135	<1000				39											
ZMM62	62		58..66	<150							43									
ZMM68	68		64..72	<200	<1000							51								
ZMM75	75		70..79.	<250									<1000	56						
ZMM82	82	1	77..87	<300		<1500			0.25	62					0.05.0.12					
ZMM91	91		85..96	<450		<2000			0.1											
ZMM100	100		94..106	<450	<5000															
ZMM110	110		104..116	<600																
ZMM120	120		114..127.	<800	<5500															
ZMM130	130		124..141	<950	<6000															
ZMM150	150		138..156	<1250	<6500															
ZMM160	160		153..171	<1400	<7000															
ZMM180	180		168..191	<1700	<8500															
ZMM200	200		188..212	<2000	<10000															

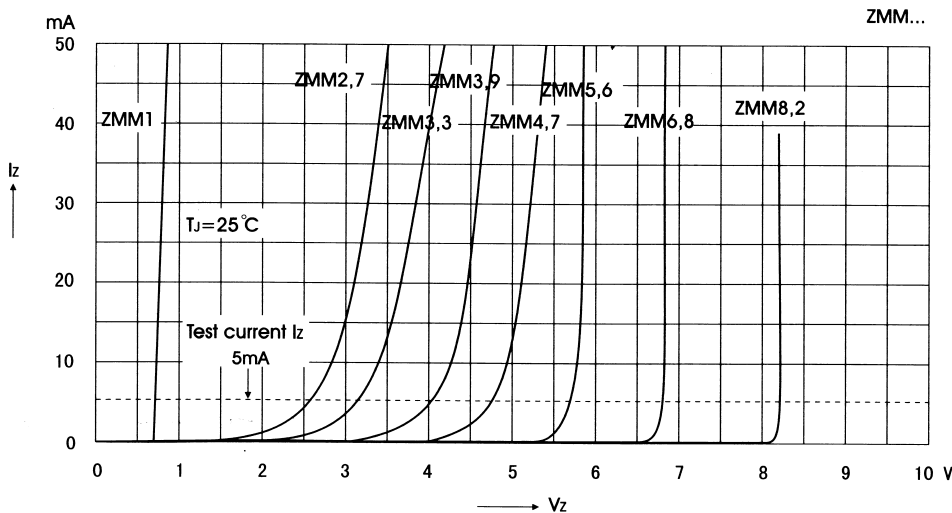
1) Tested with pluse tp=20ms

2) Valid provided that electrodes are kept at ambient temperature

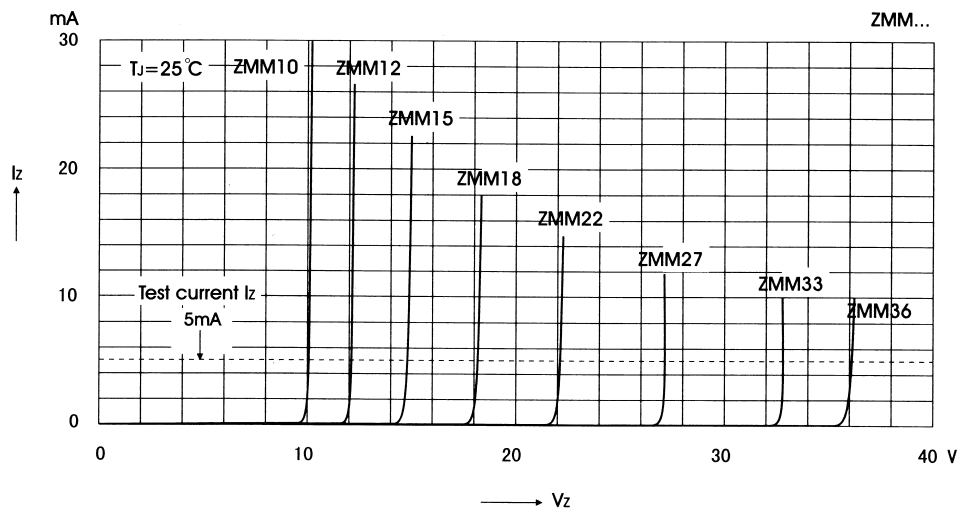
3) The ZMM1 is a silicon diode with operation in forward direction. Hence, the index of all parameters should be "F" instead of "Z", Connect the cathode to the negative pole.

ZMM1.ZMM200 SILICON PLANER ZENER DIODES

BREAKDOWN CHARACTERISTICS AT $T_J=CONSTANT$ (PULSED)

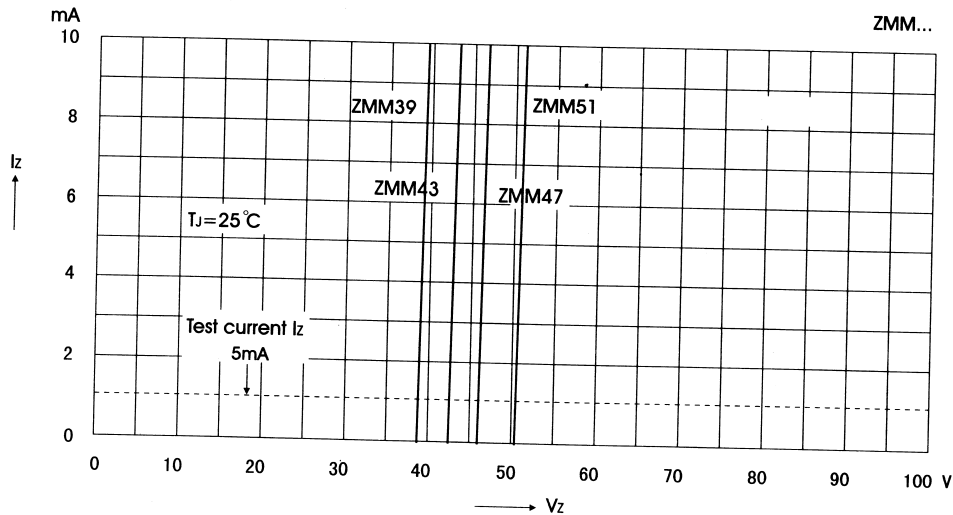


BREAKDOWN CHARACTERISTICS AT $T_J=CONSTANT$ (PULSED)

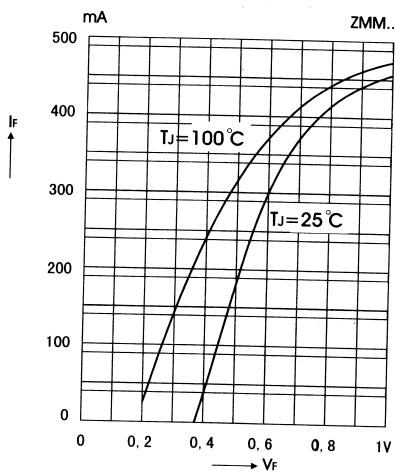


ZMM1.ZMM200 SILICON PLANER ZENER DIODES

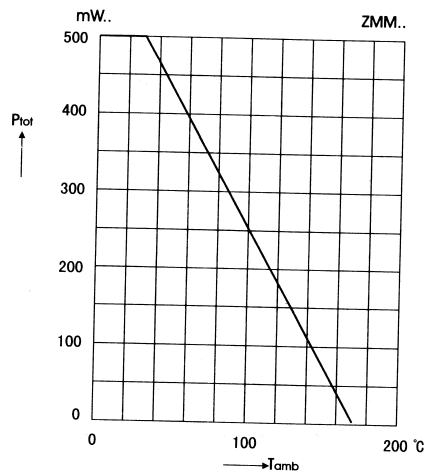
BREAKDOWN CHARACTERISTICS AT $T_J = \text{CONSTANT}$ (PULSED)



Forward Characteristics

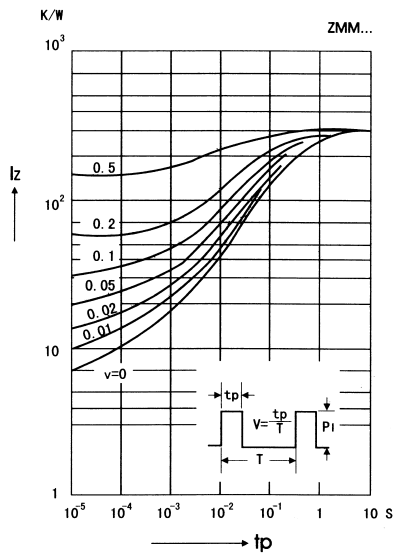


Admissible power dissipation versus ambient temperature

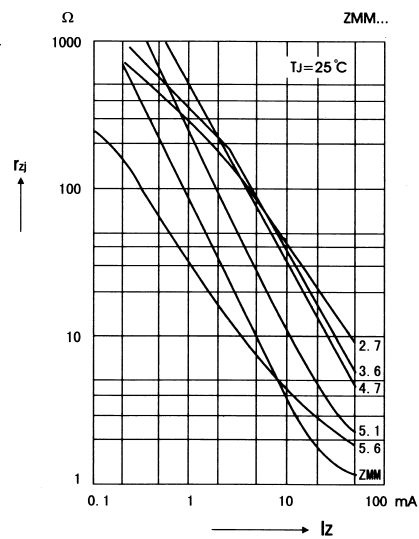


ZMM1.ZMM200 SILICON PLANER ZENER DIODES

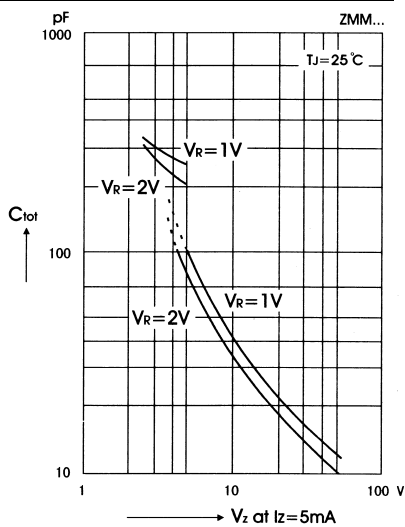
Pulse thermal resistance versus pulse duration



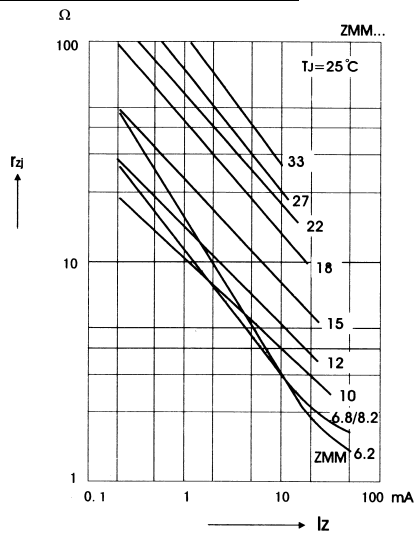
Dynamic resistance versus Zener current



Capacitance versus Zener voltage

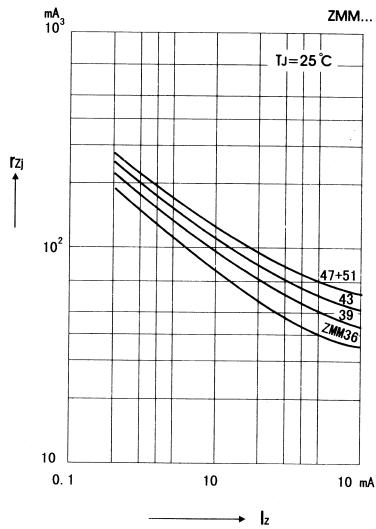


Dynamic resistance versus Zener current

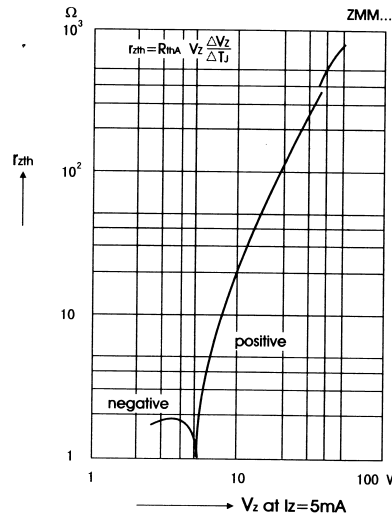


ZMM1.ZMM200 SILICON PLANER ZENER DIODES

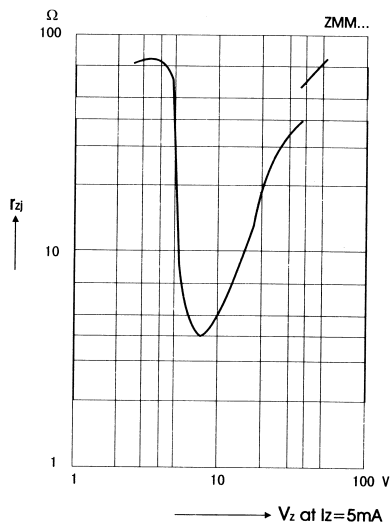
**Dynamic resistance versus
Zener current**



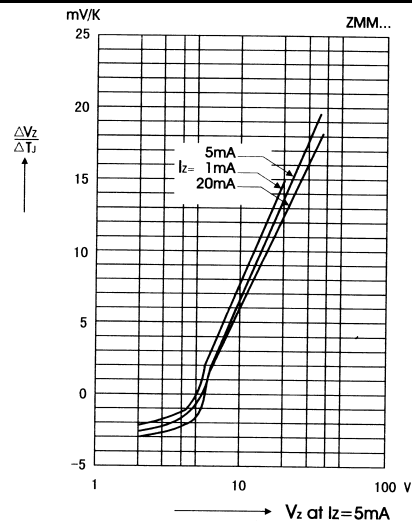
**Thermal differential resistance
versus Zener voltage**



**Dynamic resistance versus
Zener voltage**

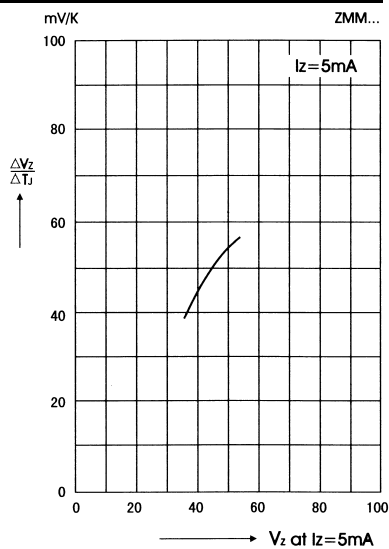


**Temperature dependence of
Zener voltage versus voltage**

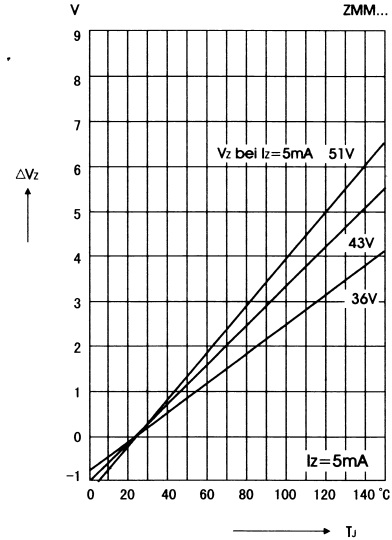


ZMM1.ZMM200 SILICON PLANER ZENER DIODES

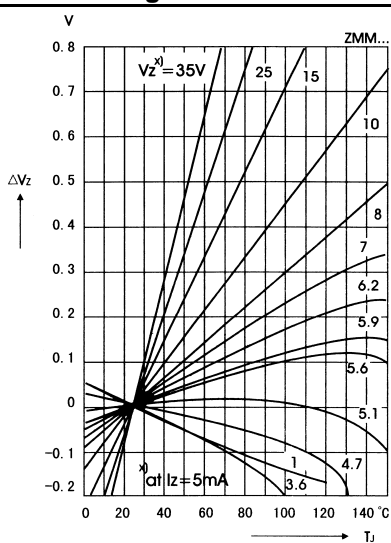
**Temperature dependence of
Zener voltage versus voltage**



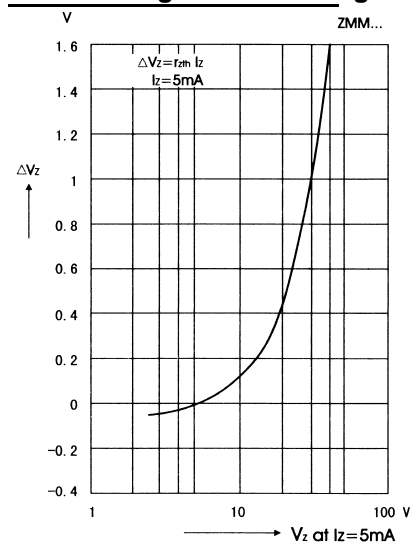
**Thermal differential resistance
versus Zener voltage**



**Dynamic resistance versus
Zener voltage**



**Temperature dependence of
Zener voltage versus voltage**



ZMM1.ZMM200 SILICON PLANER ZENER DIODES

Temperature dependence of Zener voltage versus voltage

